



# SLOVENSKI STANDARD SIST EN 61249-4-17:2010

01-januar-2010

Materialien für Leiterplatten und andere Verbindungsstrukturen -- Teil 4-17: Rahmenspezifikationen für unkaschierte Prepreg-Materialien (zur Herstellung von Mehrlagenleiterplatten) – Mit E-Glasgewebe verstärkte halogenfreie Epoxidharz-Prepregs mit definierter Brennbarkeit (Brennprüfung mit vertikaler Prüflingslage) für bleifreie Bestückungstechnik

Materials for printed boards and other interconnecting structures -- Part 4-17: Sectional specification set for prepreg materials, unclad (for the manufacture of multilayer boards) - Non-halogenated epoxide woven E-glass prepreg of defined flammability (vertical burning test) for lead-free assembly

Matériaux pour circuits imprimés et autres structures d'interconnexion -- Partie 4-17: Série de spécifications intermédiaires pour matériaux préimprégnés, non plaqués (pour la fabrication des cartes multicouches) - Tissu de verre époxyde préimprégné non halogéné de type E d'inflammabilité définie (essai de combustion verticale) destiné aux assemblages sans plomb

Ta slovenski standard je istoveten z: EN 61249-4-17:2009

**ICS:**

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**SIST EN 61249-4-17:2010**

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**Materials for printed boards and other interconnecting structures -  
 Part 4-17: Sectional specification set for prepreg materials, unclad  
 (for the manufacture of multilayer boards) -  
 Non-halogenated epoxide woven E-glass prepreg of defined flammability  
 (vertical burning test) for lead-free assembly  
 (IEC 61249-4-17:2009)**

Matériaux pour circuits imprimés  
 et autres structures d'interconnexion -  
 Partie 4-17: Série de spécifications  
 intermédiaires pour matériaux préimprégnés,  
 non plaqués  
 (pour la fabrication des cartes multicouches) -  
 Tissu de verre époxyde préimprégné  
 non halogéné de type E d'inflammabilité  
 définie (essai de combustion verticale)  
 destiné aux assemblages sans plomb  
 (CEI 61249-4-17:2009)

Materialien für Leiterplatten  
 und andere Verbindungsstrukturen -  
 Teil 4-17: Rahmenspezifikationen  
 für unkaschierte Prepreg-Materialien  
 (zur Herstellung von Mehrlagenleiterplatten) -  
 Mit E-Glasgewebe verstärkte halogenfreie  
 Epoxidharz-Prepregs  
 mit definierter Brennbarkeit  
 (Brennprüfung mit vertikaler Prüflingslage)  
 für bleifreie Bestückungstechnik  
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This European Standard was approved by CENELEC on 2009-06-01. CENELEC members are bound to comply with the CEN/CENELEC Internal Regulations which stipulate the conditions for giving this European Standard the status of a national standard without any alteration.

Up-to-date lists and bibliographical references concerning such national standards may be obtained on application to the Central Secretariat or to any CENELEC member.

This European Standard exists in three official versions (English, French, German). A version in any other language made by translation under the responsibility of a CENELEC member into its own language and notified to the Central Secretariat has the same status as the official versions.

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## CENELEC

European Committee for Electrotechnical Standardization  
 Comité Européen de Normalisation Electrotechnique  
 Europäisches Komitee für Elektrotechnische Normung

**Central Secretariat: Avenue Marnix 17, B - 1000 Brussels**

## Foreword

The text of document 91/853/FDIS, future edition 1 of IEC 61249-4-17, prepared by IEC TC 91, Electronics assembly technology, was submitted to the IEC-CENELEC parallel vote and was approved by CENELEC as EN 61249-4-17 on 2009-06-01.

The following dates were fixed:

- latest date by which the EN has to be implemented at national level by publication of an identical national standard or by endorsement (dop) 2010-03-01
- latest date by which the national standards conflicting with the EN have to be withdrawn (dow) 2012-06-01

Annex ZA has been added by CENELEC.

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## Endorsement notice

The text of the International Standard IEC 61249-4-17:2009 was approved by CENELEC as a European Standard without any modification.

In the official version, for Bibliography, the following notes have to be added for the standards indicated:

IEC 60194	NOTE Harmonized as EN 60194:2006 (not modified).
IEC 61249-2-7	NOTE Harmonized as EN 61249-2-7:2002 (not modified).
IEC 61249-2-8	NOTE Harmonized as EN 61249-2-8:2003 (not modified).
ISO 9000	NOTE Harmonized as EN ISO 9000:2005 (not modified).

## Annex ZA (normative)

### Normative references to international publications with their corresponding European publications

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE When an international publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 61189-2	2006	Test methods for electrical materials, printed boards and other interconnection structures and assemblies - Part 2: Test methods for materials for interconnection structures	EN 61189-2	2006
IEC 61249-2-38	- <sup>1)</sup>	Materials for printed boards and other interconnecting structures - Part 2-38: Reinforced base materials, clad and unclad - Non-halogenated epoxide woven E-glass laminate sheets of defined flammability (vertical burning test), copper-clad for lead-free assembly	EN 61249-2-38	2009 <sup>2)</sup>
IEC 62326-4	- <sup>1)</sup>	Printed boards - Part 4: Rigid multilayer printed boards with interlayer connections - Sectional specification	EN 62326-4	1997 <sup>2)</sup>
ISO 11014-1	1994	Safety data sheet for chemical products Part 1: Content and order of sections		-

<sup>1)</sup> Undated reference.

<sup>2)</sup> Valid edition at date of issue.

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IEC 61249-4-17

Edition 1.0 2009-05

# INTERNATIONAL STANDARD

**Materials for printed boards and other interconnecting structures –  
Part 4-17: Sectional specification set for prepreg materials, unclad (for the  
manufacture of multilayer boards) – Non-halogenated epoxide woven E-glass  
prepreg of defined flammability (vertical burning test) for lead-free assembly**

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## INTERNATIONAL ELECTROTECHNICAL COMMISSION

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**MATERIALS FOR PRINTED BOARDS AND  
OTHER INTERCONNECTING STRUCTURES –**
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## FOREWORD

- 1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as "IEC Publication(s)"). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.
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International Standard IEC 61249-4-17 has been prepared by IEC technical committee 91: Electronics assembly technology.

The text of this standard is based on the following documents:

FDIS	Report on voting
91/853/FDIS	91/865/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts of the IEC 61249 series, under the general title *Materials for printed boards and other interconnecting structures*, can be found on the IEC website.

The committee has decided that the contents of this publication will remain unchanged until the maintenance result date indicated on the IEC web site under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

A bilingual version of this publication may be issued at a later date.

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